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Sponsor DELL - Open Rack v3 - A new form-factor for high density computing

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The evolving landscape of datacenters is being impacted by the increase in power consumption of chipsets and the mainstream adoption of liquid cooling. This talk explores a new alternative to traditional 19"rack design based on the OCP Open Rack v3 form factor, focusing on the different design approach and emphasizing the scalability, performance, and sustainability advancements granted by this new industry standard.

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